

Felice Crupi

List of Publications by Citations

Source: <https://exaly.com/author-pdf/4794860/felice-crupi-publications-by-citations.pdf>

Version: 2024-04-27

This document has been generated based on the publications and citations recorded by exaly.com. For the latest version of this publication list, visit the link given above.

The third column is the impact factor (IF) of the journal, and the fourth column is the number of citations of the article.

153
papers

2,361
citations

25
h-index

39
g-index

168
ext. papers

2,910
ext. citations

2.6
avg, IF

4.87
L-index

#	Paper	IF	Citations
153	. <i>IEEE Journal of Solid-State Circuits</i> , 2011 , 46, 465-474	5.5	164
152	$1/f$ Noise in Drain and Gate Current of MOSFETs With High- k Gate Stacks. <i>IEEE Transactions on Device and Materials Reliability</i> , 2009 , 9, 180-189	1.6	86
151	On the properties of the gate and substrate current after soft breakdown in ultrathin oxide layers. <i>IEEE Transactions on Electron Devices</i> , 1998 , 45, 2329-2334	2.9	78
150	Degradation and hard breakdown transient of thin gate oxides in metal-SiO ₂ -Si capacitors: Dependence on oxide thickness. <i>Journal of Applied Physics</i> , 1999 , 86, 6382-6391	2.5	74
149	Comparative study of drain and gate low-frequency noise in nMOSFETs with hafnium-based gate dielectrics. <i>IEEE Transactions on Electron Devices</i> , 2006 , 53, 823-828	2.9	72
148	Impact strain engineering on gate stack quality and reliability. <i>Solid-State Electronics</i> , 2008 , 52, 1115-1126	6.7	56
147	Electrical and thermal transient during dielectric breakdown of thin oxides in metal-SiO ₂ -silicon capacitors. <i>Journal of Applied Physics</i> , 1998 , 84, 472-479	2.5	54
146	Impact of TFET Unidirectionality and Ambipolarity on the Performance of 6T SRAM Cells. <i>IEEE Journal of the Electron Devices Society</i> , 2015 , 3, 223-232	2.3	53
145	Mixed Tunnel-FET/MOSFET Level Shifters: A New Proposal to Extend the Tunnel-FET Application Domain. <i>IEEE Transactions on Electron Devices</i> , 2015 , 62, 3973-3979	2.9	47
144	Impact of the interfacial layer on the low-frequency noise (1/f) behavior of MOSFETs with advanced gate stacks. <i>IEEE Electron Device Letters</i> , 2006 , 27, 688-691	4.4	45
143	Reliability Comparison of Triple-Gate Versus Planar SOI FETs. <i>IEEE Transactions on Electron Devices</i> , 2006 , 53, 2351-2357	2.9	43
142	Design of a 75-nW, 0.5-V subthreshold complementary metal-oxide-semiconductor operational amplifier. <i>International Journal of Circuit Theory and Applications</i> , 2014 , 42, 967-977	2	41
141	On the Temperature and Field Dependence of Trap-Assisted Tunneling Current in Ge p^+n Junctions. <i>IEEE Electron Device Letters</i> , 2009 , 30, 562-564	4.4	41
140	. <i>IEEE Transactions on Electron Devices</i> , 2011 , 58, 2347-2353	2.9	40
139	Digital and analog TFET circuits: Design and benchmark. <i>Solid-State Electronics</i> , 2018 , 146, 50-65	1.7	40
138	Understanding the Potential and Limitations of Tunnel FETs for Low-Voltage Analog/Mixed-Signal Circuits. <i>IEEE Transactions on Electron Devices</i> , 2017 , 64, 2736-2743	2.9	39
137	A Sub- kT/q Voltage Reference Operating at 150 mV. <i>IEEE Transactions on Very Large Scale Integration (VLSI) Systems</i> , 2015 , 23, 1547-1551	2.6	39

136	An Ultralow-Voltage Energy-Efficient Level Shifter. <i>IEEE Transactions on Circuits and Systems II: Express Briefs</i> , 2017 , 64, 61-65	3.5	38
135	Modeling of Tunnelling Currents in Hf-Based Gate Stacks as a Function of Temperature and Extraction of Material Parameters. <i>IEEE Transactions on Electron Devices</i> , 2007 , 54, 83-89	2.9	36
134	Assessment of InAs/AlGaSb Tunnel-FET Virtual Technology Platform for Low-Power Digital Circuits. <i>IEEE Transactions on Electron Devices</i> , 2016 , 63, 2749-2756	2.9	33
133	Positive Bias Temperature Instability in nMOSFETs with ultra-thin Hf-silicate gate dielectrics. <i>Microelectronic Engineering</i> , 2005 , 80, 130-133	2.5	32
132	Opto-electrical modelling and optimization study of a novel IBC c-Si solar cell. <i>Progress in Photovoltaics: Research and Applications</i> , 2017 , 25, 452-469	6.8	27
131	Bipolar Mode Operation and Scalability of Double-Gate Capacitorless 1T-DRAM Cells. <i>IEEE Transactions on Electron Devices</i> , 2010 , 57, 1743-1750	2.9	27
130	A Variation-Aware Timing Modeling Approach for Write Operation in Hybrid CMOS/STT-MTJ Circuits. <i>IEEE Transactions on Circuits and Systems I: Regular Papers</i> , 2018 , 65, 1086-1095	3.9	26
129	A Compact Model with Spin-Polarization Asymmetry for Nanoscaled Perpendicular MTJs. <i>IEEE Transactions on Electron Devices</i> , 2017 , 64, 4346-4353	2.9	26
128	How to enlarge the bandwidth without increasing the noise in OP-AMP-based transimpedance amplifier. <i>IEEE Transactions on Instrumentation and Measurement</i> , 2006 , 55, 814-819	5.2	24
127	Low-frequency (1/f) noise behavior of locally stressed HfO ₂ /sub 2//TiN gate-stack pMOSFETs. <i>IEEE Electron Device Letters</i> , 2006 , 27, 508-510	4.4	24
126	On the role of interface states in low-voltage leakage currents of metal-oxide-semiconductor structures. <i>Applied Physics Letters</i> , 2002 , 80, 4597-4599	3.4	24
125	Understanding the Basic Advantages of Bulk FinFETs for Sub- and Near-Threshold Logic Circuits From Device Measurements. <i>IEEE Transactions on Circuits and Systems II: Express Briefs</i> , 2012 , 59, 439-442	3.5	23
124	Variability-Aware Analysis of Hybrid MTJ/CMOS Circuits by a Micromagnetic-Based Simulation Framework. <i>IEEE Nanotechnology Magazine</i> , 2017 , 16, 160-168	2.6	22
123	Theory and experiment of suppressed shot noise in 'stress-induced leakage currents. <i>IEEE Transactions on Electron Devices</i> , 2003 , 50, 1363-1369	2.9	21
122	On recoverable behavior of PBTI in AlGaIn/GaN MOS-HEMT. <i>Solid-State Electronics</i> , 2017 , 132, 49-56	1.7	20
121	Matching Performance of FinFET Devices With Fin Widths Down to 10 nm. <i>IEEE Electron Device Letters</i> , 2009 , 30, 1374-1376	4.4	20
120	Soft breakdown of gate oxides in metal-oxide-semiconductor capacitors under stress with hot electrons. <i>Applied Physics Letters</i> , 1999 , 75, 1161-1163	3.4	19
119	Impact of AlN layer sandwiched between the GaN and the Al ₂ O ₃ layers on the performance and reliability of recessed AlGaIn/GaN MOS-HEMTs. <i>Microelectronic Engineering</i> , 2017 , 178, 42-47	2.5	18

118	FinFET Mismatch in Subthreshold Region: Theory and Experiments. <i>IEEE Transactions on Electron Devices</i> , 2010 , 57, 2848-2856	2.9	18
117	A New Circuit Topology for the Realization of Very Low-Noise Wide-Bandwidth Transimpedance Amplifier. <i>IEEE Transactions on Instrumentation and Measurement</i> , 2007 , 56, 1626-1631	5.2	18
116	Very low-noise, high-accuracy programmable voltage reference. <i>IEEE Transactions on Instrumentation and Measurement</i> , 2003 , 52, 1251-1254	5.2	18
115	Room-temperature single-electron effects in silicon nanocrystal memories. <i>Applied Physics Letters</i> , 2005 , 87, 182106	3.4	18
114	Suppressed shot noise in trap-assisted tunneling of metal-oxide-semiconductor capacitors. <i>Applied Physics Letters</i> , 2000 , 77, 2876-2878	3.4	18
113	Pre-breakdown in thin SiO ₂ Films. <i>IEEE Electron Device Letters</i> , 2000 , 21, 319-321	4.4	17
112	Numerical simulations of hole carrier selective contacts in p-type c-Si solar cells. <i>Solar Energy Materials and Solar Cells</i> , 2019 , 200, 109937	6.4	16
111	Resistive switching characteristics of integrated polycrystalline hafnium oxide based one transistor and one resistor devices fabricated by atomic vapor deposition methods. <i>Journal of Vacuum Science and Technology B: Nanotechnology and Microelectronics</i> , 2015 , 33, 052204	1.3	16
110	Characterization and Modeling of Hot Carrier-Induced Variability in Subthreshold Region. <i>IEEE Transactions on Electron Devices</i> , 2012 , 59, 2093-2099	2.9	16
109	Observation of peripheral charge induced low frequency capacitance-voltage behaviour in metal-oxide-semiconductor capacitors on Si and GaAs substrates. <i>Journal of Applied Physics</i> , 2012 , 111, 124104	2.5	16
108	Low Frequency Noise and Gate Bias Instability in Normally OFF AlGa _N /Ga _N HEMTs. <i>IEEE Transactions on Electron Devices</i> , 2016 , 63, 2219-2222	2.9	16
107	Assessment of STT-MRAM performance at nanoscaled technology nodes using a device-to-memory simulation framework. <i>Microelectronic Engineering</i> , 2019 , 215, 111009	2.5	15
106	. <i>IEEE Transactions on Electron Devices</i> , 2009 , 56, 1063-1069	2.9	15
105	Impact of Si-thickness on interface and device properties for Si-passivated Ge pMOSFETs 2008 ,		15
104	Reduction of thermal damage in ultrathin gate oxides after intrinsic dielectric breakdown. <i>Applied Physics Letters</i> , 2001 , 79, 1522-1524	3.4	15
103	Back-gated Nb-doped MoS ₂ junctionless field-effect-transistors. <i>AIP Advances</i> , 2016 , 6, 025323	1.5	15
102	Reliability Improvements in AlGa _N /Ga _N Schottky Barrier Diodes With a Gated Edge Termination. <i>IEEE Transactions on Electron Devices</i> , 2018 , 65, 1765-1770	2.9	14
101	A picopower temperature-compensated, subthreshold CMOS voltage reference. <i>International Journal of Circuit Theory and Applications</i> , 2014 , 42, 1306-1318	2	14

100	Impact of the Substrate Orientation on CHC Reliability in n-FinFETs Separation of the Various Contributions. <i>IEEE Transactions on Device and Materials Reliability</i> , 2014 , 14, 52-56	1.6	14
99	Barrier Lowering and Backscattering Extraction in Short-Channel MOSFETs. <i>IEEE Transactions on Electron Devices</i> , 2010 , 57, 2132-2137	2.9	14
98	Compact Modeling of Perpendicular STT-MTJs With Double Reference Layers. <i>IEEE Nanotechnology Magazine</i> , 2019 , 18, 1063-1070	2.6	13
97	Low-frequency noise assessment of border traps in Al ₂ O ₃ capped DRAM peripheral MOSFETs. <i>Semiconductor Science and Technology</i> , 2014 , 29, 115015	1.8	13
96	Gate voltage and geometry dependence of the series resistance and of the carrier mobility in FinFET devices. <i>Microelectronic Engineering</i> , 2008 , 85, 1728-1731	2.5	13
95	Enhanced sensitivity cross-correlation method for voltage noise measurements. <i>IEEE Transactions on Instrumentation and Measurement</i> , 2006 , 55, 1143-1147	5.2	13
94	Numerical simulation of the impact of design parameters on the performance of back-contact back-junction solar cell. <i>Journal of Computational Electronics</i> , 2016 , 15, 260-268	1.8	12
93	Diagnosis of phosphorus monolayer doping in silicon based on nanowire electrical characterisation. <i>Journal of Applied Physics</i> , 2018 , 123, 125701	2.5	12
92	DC and low-frequency noise behavior of the conductive filament in bipolar HfO ₂ -based resistive random access memory. <i>Microelectronic Engineering</i> , 2013 , 107, 1-5	2.5	12
91	Benchmarks of a III-V TFET technology platform against the 10-nm CMOS FinFET technology node considering basic arithmetic circuits. <i>Solid-State Electronics</i> , 2017 , 128, 37-42	1.7	12
90	Defect-Centric Distribution of Channel Hot Carrier Degradation in Nano-MOSFETs. <i>IEEE Electron Device Letters</i> , 2014 , 35, 1167-1169	4.4	12
89	Cross-correlation-based trans-impedance amplifier for current noise measurements. <i>International Journal of Circuit Theory and Applications</i> , 2009 , 37, 781-792	2	12
88	Implications of fin width scaling on variability and reliability of high-k metal gate FinFETs. <i>Microelectronic Engineering</i> , 2010 , 87, 1963-1967	2.5	12
87	On the dc and noise properties of the gate current in epitaxial Ge p-channel metal oxide semiconductor field effect transistors with TiN/TaN/HfO ₂ /BiO ₂ gate stack. <i>Applied Physics Letters</i> , 2008 , 92, 163508	3.4	12
86	Performance and Reliability of Strained-Silicon nMOSFETs With SiN Cap Layer. <i>IEEE Transactions on Electron Devices</i> , 2007 , 54, 78-82	2.9	12
85	Micro-prober for wafer-level low-noise measurements in MOS devices. <i>IEEE Transactions on Instrumentation and Measurement</i> , 2003 , 52, 1533-1536	5.2	12
84	A comparative study of the oxide breakdown in short-channel nMOSFETs and pMOSFETs stressed in inversion and in accumulation regimes. <i>IEEE Transactions on Device and Materials Reliability</i> , 2003 , 3, 8-13	1.6	12
83	New insights into the relation between channel hot carrier degradation and oxide breakdown short channel nMOSFETs. <i>IEEE Electron Device Letters</i> , 2003 , 24, 278-280	4.4	12

82	A novel methodology for sensing the breakdown location and its application to the reliability study of ultrathin HF-silicate gate dielectrics. <i>IEEE Transactions on Electron Devices</i> , 2005 , 52, 1759-1765	2.9	12
81	Assessment of STT-MRAMs based on double-barrier MTJs for cache applications by means of a device-to-system level simulation framework. <i>The Integration VLSI Journal</i> , 2020 , 71, 56-69	1.4	11
80	. <i>IEEE Journal of Photovoltaics</i> , 2013 , 3, 1215-1221	3.7	11
79	. <i>IEEE Transactions on Nuclear Science</i> , 2010 , 57, 2309-2317	1.7	11
78	Exploiting STT-MRAMs for Cryogenic Non-Volatile Cache Applications. <i>IEEE Nanotechnology Magazine</i> , 2021 , 20, 123-128	2.6	11
77	Characterization of soft breakdown in thin oxide NMOSFETs based on the analysis of the substrate current. <i>IEEE Transactions on Electron Devices</i> , 2001 , 48, 1109-1113	2.9	10
76	Border Traps in InGaAs nMOSFETs Assessed by Low-Frequency Noise. <i>IEEE Electron Device Letters</i> , 2014 , 35, 720-722	4.4	9
75	Analysis of the Impact of Doping Levels on Performance of back Contact-Back Junction Solar Cells. <i>Energy Procedia</i> , 2014 , 55, 128-132	2.3	9
74	A Methodology to Account for the Finger Non-Uniformity in Photovoltaic Solar Cell. <i>Energy Procedia</i> , 2012 , 27, 191-196	2.3	9
73	BTI reliability of ultra-thin EOT MOSFETs for sub-threshold logic. <i>Microelectronics Reliability</i> , 2012 , 52, 1932-1935	1.2	9
72	Simulation Analysis of DMTJ-Based STT-MRAM Operating at Cryogenic Temperatures. <i>IEEE Transactions on Magnetics</i> , 2021 , 57, 1-6	2	9
71	Trimming-Less Voltage Reference for Highly Uncertain Harvesting Down to 0.25 V, 5.4 pW. <i>IEEE Journal of Solid-State Circuits</i> , 2021 , 56, 3134-3144	5.5	9
70	Tuning the switching behavior of conductive-bridge resistive memory by the modulation of the cation-supplier alloys. <i>Microelectronic Engineering</i> , 2017 , 167, 47-51	2.5	8
69	. <i>IEEE Transactions on Electron Devices</i> , 2011 , 58, 691-697	2.9	8
68	Single-Electron Program/Erase Tunnel Events in Nanocrystal Memories. <i>IEEE Nanotechnology Magazine</i> , 2007 , 6, 35-42	2.6	8
67	Shot noise partial suppression in the SILO regime. <i>Microelectronics Reliability</i> , 2000 , 40, 1605-1608	1.2	8
66	Gate-level body biasing for subthreshold logic circuits: analytical modeling and design guidelines. <i>International Journal of Circuit Theory and Applications</i> , 2015 , 43, 1523-1540	2	7
65	A portable class of 3-transistor current references with low-power sub-0.5V operation. <i>International Journal of Circuit Theory and Applications</i> , 2018 , 46, 779-795	2	7

64	A physical unclonable function based on a 2-transistor subthreshold voltage divider. <i>International Journal of Circuit Theory and Applications</i> , 2017 , 45, 260-273	2	7
63	A methodology to account for the finger interruptions in solar cell performance. <i>Microelectronics Reliability</i> , 2012 , 52, 2500-2503	1.2	7
62	Impact of High-Mobility Materials on the Performance of Near- and Sub-Threshold CMOS Logic Circuits. <i>IEEE Transactions on Electron Devices</i> , 2013 , 60, 972-977	2.9	7
61	Structural and Electrical Analysis of Thin Interface Control Layers of MgO or Al ₂ O ₃ Deposited by Atomic Layer Deposition and Incorporated at the High-k/III-V Interface of MO ₂ /In _x Ga _{1-x} As (M = Hf Zr, x = 0 0.53) Gate Stacks. <i>ECS Transactions</i> , 2010 , 33, 69-82	1	7
60	Si _{1-x} Ge _x -Channel PFETs: Scalability, Layout Considerations and Compatibility with Other Stress Techniques. <i>ECS Transactions</i> , 2011 , 35, 493-503	1	7
59	Full Model and Characterization of Noise in Operational Amplifier. <i>IEEE Transactions on Circuits and Systems I: Regular Papers</i> , 2009 , 56, 97-102	3.9	7
58	On the Impact of Defects Close to the Gate Electrode on the Low-Frequency $1/f$ Noise. <i>IEEE Electron Device Letters</i> , 2008 , 29, 1056-1058	4.4	7
57	Investigation and Comparison of the Noise in the Gate and Substrate Current after Soft-Breakdown. <i>Japanese Journal of Applied Physics</i> , 1999 , 38, 2219-2222	1.4	7
56	Implications of the Incremental Pulse and Verify Algorithm on the Forming and Switching Distributions in RERAM Arrays. <i>IEEE Transactions on Device and Materials Reliability</i> , 2016 , 16, 413-418	1.6	7
55	Relaxing non-volatility for energy-efficient DMTJ based cryogenic STT-MRAM. <i>Solid-State Electronics</i> , 2021 , 184, 108090	1.7	7
54	Buried Silicon-Germanium pMOSFETs: Experimental Analysis in VLSI Logic Circuits Under Aggressive Voltage Scaling. <i>IEEE Transactions on Very Large Scale Integration (VLSI) Systems</i> , 2012 , 20, 1487-1495	2.6	6
53	Three-channel amplifier for high-sensitivity voltage noise measurements. <i>Review of Scientific Instruments</i> , 2006 , 77, 095104	1.7	6
52	Modelling doping design in nanowire tunnel-FETs based on group-IV semiconductors. <i>Materials Science in Semiconductor Processing</i> , 2017 , 62, 201-204	4.3	5
51	The Role of the Interfaces in the $1/f$ Noise of MOSFETs with High-k Gate Stacks. <i>ECS Transactions</i> , 2009 , 19, 87-99	1	5
50	Low frequency current noise in unstressed/stressed thin oxide metal-oxide-semiconductor capacitors. <i>Solid-State Electronics</i> , 2002 , 46, 1807-1813	1.7	5
49	A Defect-Centric perspective on channel hot carrier variability in nMOSFETs. <i>Microelectronic Engineering</i> , 2015 , 147, 72-74	2.5	4
48	Impact of voltage scaling on STT-MRAMs through a variability-aware simulation framework 2017 ,		4
47	A sub-1 V nanopower temperature-compensated sub-threshold CMOS voltage reference with 0.065%/V line sensitivity. <i>International Journal of Circuit Theory and Applications</i> , 2015 , 43, 421-426	2	4

46	Analysis of TFET based 6T SRAM cells implemented with state of the art silicon nanowires 2014 ,		4
45	A Backscattering Model Incorporating the Effective Carrier Temperature in Nano-MOSFET. <i>IEEE Electron Device Letters</i> , 2011 , 32, 853-855	4-4	4
44	Criticisms on and comparison of experimental channel backscattering extraction methods. <i>Microelectronic Engineering</i> , 2011 , 88, 76-81	2.5	4
43	Electron transport through electrically induced nanoconstrictions in HfSiON gate stacks. <i>Applied Physics Letters</i> , 2008 , 92, 253505	3-4	4
42	Performance of current mirror with high-k gate dielectrics. <i>Microelectronic Engineering</i> , 2008 , 85, 284-288.5		4
41	Current noise at the oxide hard-breakdown. <i>Microelectronic Engineering</i> , 2001 , 59, 43-47	2.5	4
40	Structural and Electrical Investigation of MoS ₂ Thin Films Formed by Thermal Assisted Conversion of Mo Metal. <i>ECS Journal of Solid State Science and Technology</i> , 2016 , 5, Q3016-Q3020	2	4
39	A variation-aware simulation framework for hybrid CMOS/spintronic circuits 2017 ,		3
38	Exploiting Double-Barrier MTJs for Energy-Efficient Nanoscaled STT-MRAMs 2019 ,		3
37	Analysis of the impact of rear side geometry on performance of back-contact back-junction solar cells 2014 ,		3
36	Low energy/delay overhead level shifter for wide-range voltage conversion. <i>International Journal of Circuit Theory and Applications</i> , 2017 , 45, 1637-1646	2	3
35	Detection and Classification of Single-Electron Jumps in Si Nanocrystal Memories. <i>IEEE Transactions on Instrumentation and Measurement</i> , 2008 , 57, 364-368	5-2	3
34	Interfacial layer quality effects on low-frequency noise (1/f) in p-MOSFETs with advanced gate stacks. <i>Microelectronics Reliability</i> , 2007 , 47, 501-504	1.2	3
33	Two-channel amplifier for high-sensitivity voltage noise measurements. <i>Conference Record - IEEE Instrumentation and Measurement Technology Conference</i> , 2007 ,		3
32	Influence of GaN- and Si ₃ N ₄ -Passivation Layers on the Performance of AlGaN/GaN Diodes With a Gated Edge Termination. <i>IEEE Transactions on Electron Devices</i> , 2019 , 66, 883-889	2.9	3
31	A 0.05 mm ² , 350 mV, 14 nW Fully-Integrated Temperature Sensor in 180-nm CMOS. <i>IEEE Transactions on Circuits and Systems II: Express Briefs</i> , 2021 , 1-1	3-5	3
30	A 0.6-to-1.8V CMOS Current Reference With Near-100% Power Utilization. <i>IEEE Transactions on Circuits and Systems II: Express Briefs</i> , 2021 , 68, 3038-3042	3-5	3
29	STT-MTJ Based Smart Implication for Energy-Efficient Logic-in-Memory Computing. <i>Solid-State Electronics</i> , 2021 , 184, 108065	1.7	3

28	Static CMOS Physically Unclonable Function Based on 4T Voltage Divider With 0.6%-1.5% Bit Instability at 0.4-1.8 V Operation in 180 nm. <i>IEEE Journal of Solid-State Circuits</i> , 2022 , 1-12	5.5	3
27	Electrical Characterization of the Influence of the Annealing Energy Density on Carrier Lifetimes in Germanium. <i>ECS Journal of Solid State Science and Technology</i> , 2016 , 5, P3013-P3017	2	2
26	Single Defect Discharge Events in Vertical-Nanowire Tunnel-FETs. <i>IEEE Transactions on Device and Materials Reliability</i> , 2017 , 17, 253-258	1.6	2
25	Reliability Assessment of AlGaIn/GaN Schottky Barrier Diodes Under ON-State Stress. <i>IEEE Transactions on Device and Materials Reliability</i> , 2020 , 20, 167-171	1.6	2
24	Understanding the Optimization of the Emitter Coverage in BC-BJ Solar Cells. <i>Energy Procedia</i> , 2015 , 77, 149-152	2.3	2
23	Performance and reliability of ultra-thin oxide nMOSFETs under variable body bias. <i>Microelectronic Engineering</i> , 2007 , 84, 1947-1950	2.5	2
22	Low frequency noise in nMOSFETs with subnanometer EOT hafnium-based gate dielectrics. <i>Microelectronics Reliability</i> , 2007 , 47, 2109-2113	1.2	2
21	Transients during pre-breakdown and hard breakdown of thin gate oxides in metal/SiO ₂ /Si capacitors. <i>Materials Science in Semiconductor Processing</i> , 1999 , 2, 359-367	4.3	2
20	Making IoT Services Accountable: A Solution Based on Blockchain and Physically Unclonable Functions. <i>Lecture Notes in Computer Science</i> , 2019 , 294-305	0.9	2
19	A Low-Voltage, Low-Power Reconfigurable Current-Mode Softmax Circuit for Analog Neural Networks. <i>Electronics (Switzerland)</i> , 2021 , 10, 1004	2.6	2
18	Understanding the impact of point-contact scheme and selective emitter in a c-Si BC-BJ solar cell by full 3D numerical simulations. <i>Solar Energy</i> , 2017 , 155, 1443-1450	6.8	1
17	BTI saturation and universal relaxation in SiC power MOSFETs. <i>Microelectronics Reliability</i> , 2020 , 109, 113642	1.2	1
16	A Comparative Study of MWT Architectures by Means of Numerical Simulations. <i>Energy Procedia</i> , 2013 , 38, 131-136	2.3	1
15	Measurements and Simulations on the Mechanisms of Efficiency Losses in HIT Solar Cells. <i>International Journal of Photoenergy</i> , 2015 , 2015, 1-7	2.1	1
14	Experimental analysis of buried SiGe pMOSFETs from the perspective of aggressive voltage scaling 2011 ,		1
13	Multiple gate NVM cells with improved Fowler-Nordheim tunneling program and erase performances. <i>Solid-State Electronics</i> , 2010 , 54, 1319-1325	1.7	1
12	Impact of Scaling on Physical Unclonable Function Based on Spin-Orbit Torque. <i>IEEE Magnetics Letters</i> , 2020 , 11, 1-5	1.6	1
11	A Robust, High-Speed and Energy-Efficient Ultralow-Voltage Level Shifter. <i>IEEE Transactions on Circuits and Systems II: Express Briefs</i> , 2021 , 68, 1393-1397	3.5	1

10	Design guidelines for a metallization scheme with multiple-emitter contact lines in BC-BJ solar cells. <i>Journal of Computational Electronics</i> , 2016 , 15, 1498-1504	1.8	1
9	An Energy Aware Variation-Tolerant Writing Termination Control for STT-based Non Volatile Flip-Flops 2019 ,		1
8	Assessment of 2D-FET Based Digital and Analog Circuits on Paper. <i>Solid-State Electronics</i> , 2021 , 185, 108063	1.7	1
7	Assessment of paper-based MoS ₂ FET for Physically Unclonable Functions. <i>Solid-State Electronics</i> , 2022 , 194, 108391	1.7	1
6	Forward to the Special Section on Reliability of High-Mobility Channel Materials <i>IEEE Transactions on Device and Materials Reliability</i> , 2013 , 13, 428-428	1.6	
5	Impact of the variable output resistance on the transient response of LC transmission line CMOS buffers and its model. <i>Microwave and Optical Technology Letters</i> , 2007 , 49, 1504-1509	1.2	
4	Comparison of stressed Poly-Si and TiN gated HF-based NMOSFETs characteristics, modeling and their impact on circuits performance. <i>Microelectronic Engineering</i> , 2007 , 84, 2113-2116	2.5	
3	Modeling pFET currents after soft breakdown at different gate locations. <i>Microelectronic Engineering</i> , 2004 , 72, 125-129	2.5	
2	Adjusting thermal stability in double-barrier MTJ for energy improvement in cryogenic STT-MRAMs. <i>Solid-State Electronics</i> , 2022 , 194, 108315	1.7	
1	Smart Material Implication Using Spin-Transfer Torque Magnetic Tunnel Junctions for Logic-in-Memory Computing. <i>Solid-State Electronics</i> , 2022 , 108390	1.7	